1586039-6 ACTIVE

VAL-U-LOK

TE Internal #: 1586039-6

PCB Mount Header, Vertical, Wire-to-Board, 6 Position, 4.2 mm [. 165 in] Centerline, Fully Shrouded, Tin (Sn), Through Hole - Solder,

Power, Natural
View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles











PCB Connector Type: PCB Mount Header

PCB Mount Orientation: Vertical
Connector System: Wire-to-Board

Number of Positions: 6
Number of Rows: 2

Features

Product Type Features

Connector Shape	Rectangular
PCB Connector Type	PCB Mount Header
Connector System	Wire-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Connector Product Type	Connector Assembly
Configuration Features	
Number of Loaded Positions	6
Number of Power Positions	6
PCB Mount Orientation	Vertical
Number of Positions	6
Number of Rows	2



Primary Product Color Natural Contact Features Contact Underplating Material Contact Underplating Material Thickness Contact Mating Area Plating Material Thickness Contact Termination Area Plating Material Thickness Contact Layout Contact Base Material PCB Contact Termination Area Plating Material Thickness Contact Base Material PCB Contact Termination Area Plating Material Tin Contact Mating Area Plating Material Tin Contact Mating Area Plating Material Tin (Sn) Contact Type Tab Contact Current Rating (Max) ermination Features Termination Post & Tail Length Termination Method to PCB Mating Retention Type Mating Retention Mating Retention Mating Alignment Type PCB Mount Retention Type Boardloce PCB Mount Retention Type Boardloce	[80 µin]
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Mating Retention Type Locking Mating Retention With Mating Alignment Type Keyed	138 in]
Mating Retention Type Mating Retention With Mating Alignment Type Keyed	Hole - Solder
Mating Retention With Mating Alignment Type Keyed	
Mating Alignment Type Keyed	ГаЬ
PCB Mount Retention Type Boardloo	
	k
PCB Mount Retention With	
PCB Mount Alignment Without	
Connector Mounting Type Board M	ount
Mating Alignment With	
lousing Features	
Housing Material PA 66	
Centerline (Pitch) 4.2 mm[.	
Dimensions	165 in]
Row-to-Row Spacing 4.2 mm[.	165 in]
Connector Width 9.75 mm	



PCB Thickness (Recommended)	1.78 mm[.07 in]
Connector Height	12.8 mm[.504 in]
Connector Length	13.8 mm[.543 in]
Usage Conditions	
Operating Temperature (Max)	105 °C[221 °F]
Operating Temperature Range	-40 - 105 °C[-40 - 221 °F]
Operation/Application	
Circuit Application	Power
Industry Standards	
Industry Standards Compatible With Agency/Standards Products	CSA, UL
	CSA, UL Recognized
Compatible With Agency/Standards Products	
Compatible With Agency/Standards Products UL Rating	Recognized
Compatible With Agency/Standards Products UL Rating Compatible With Approved Standards Products	Recognized UL E28476
Compatible With Agency/Standards Products UL Rating Compatible With Approved Standards Products Glow Wire Rating	Recognized UL E28476 Standard Part - Not Glow Wire
Compatible With Agency/Standards Products UL Rating Compatible With Approved Standards Products Glow Wire Rating UL Flammability Rating	Recognized UL E28476 Standard Part - Not Glow Wire

Product Compliance

Packaging Method

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Wave solder capable to 265°C

Tray

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as



EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

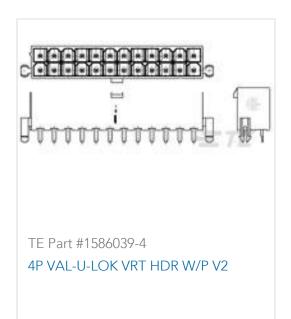
Compatible Parts







Customers Also Bought























Documents

Product Drawings

6P VAL-U-LOK VRT HDR W/P V2

English

CAD Files

3D PDF

English

Customer View Model

ENG_CVM_1586039-6_B.3d_stp.zip

English

Customer View Model

ENG_CVM_1586039-6_B.2d_dxf.zip

English

Customer View Model

ENG_CVM_1586039-6_B.3d_igs.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

SOFT_SHELL_PIN_AND_SOCKET_CONNECTORS_CATALOG

English

Product Specifications

Application Specification

English

Agency Approvals

UL Report

English

UL Report

English